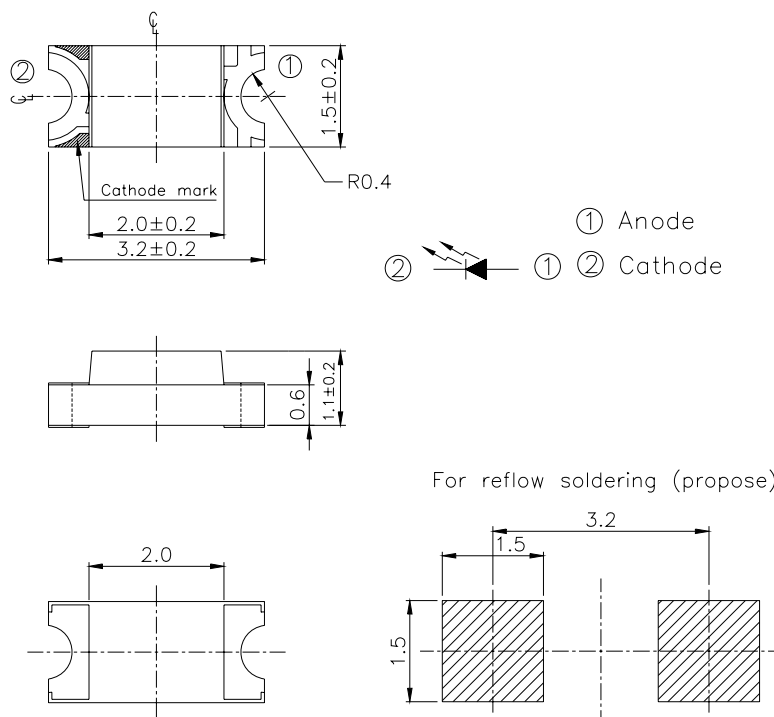


Package Dimensions



Notes: 1.All dimensions are in millimeters

2.Tolerances unless dimensions $\pm 0.1\text{mm}$

Absolute Maximum Ratings ($T_a=25^\circ\text{C}$)

| Parameter | Symbol | Rating | Units |
|--|-----------|----------------|------------------|
| Continuous Forward Current | I_F | 65 | mA |
| Peak Forward Current*1 | I_{FP} | 1.0 | A |
| Reverse Voltage | V_R | 5 | V |
| Operating Temperature | T_{opr} | $-40 \sim +85$ | $^\circ\text{C}$ |
| Storage Temperature | T_{stg} | $-40 \sim +85$ | $^\circ\text{C}$ |
| Soldering Temperature*2 | T_{sol} | 260 | $^\circ\text{C}$ |
| Power Dissipation at(or below) 25 $^\circ\text{C}$ Free Air Temperature | P_d | 130 | mW |

Notes: *1: I_{FP} Conditions--Pulse Width $\leq 100 \mu\text{s}$ and Duty $\leq 1\%$.

*2:Soldering time ≤ 5 seconds.

Electro-Optical Characteristics (Ta=25°C)

| Parameter | Symbol | Condition | Min. | Typ. | Max. | Units |
|--------------------|------------------|-------------------|------|------|------|---------------|
| Radiant Intensity | I_E | $I_F=20\text{mA}$ | 0.2 | 0.8 | -- | mW/sr |
| Peak Wavelength | λ_p | $I_F=20\text{mA}$ | -- | 940 | -- | nm |
| Spectral Bandwidth | $\Delta \lambda$ | $I_F=20\text{mA}$ | -- | 45 | -- | nm |
| Forward Voltage | V_F | $I_F=20\text{mA}$ | -- | 1.2 | 1.5 | V |
| Reverse Current | I_R | $V_R=5\text{V}$ | -- | -- | 10 | μA |
| View Angle | $2\theta_{1/2}$ | $I_F=20\text{mA}$ | -- | 160 | -- | deg |

Intensity Specifications for Bin Grading

| Rank | Test Condition | Min | Max | Unit |
|------|-------------------|-----|-----|-------|
| E | $I_F=20\text{mA}$ | 0.2 | 1.0 | mW/sr |
| F | | 0.5 | 1.5 | |
| G | | 1.0 | 2.5 | |
| H | | 2.0 | 3.5 | |

Typical Electro-Optical Characteristics Curves

Fig.1 Forward Current vs. Ambient Temperature

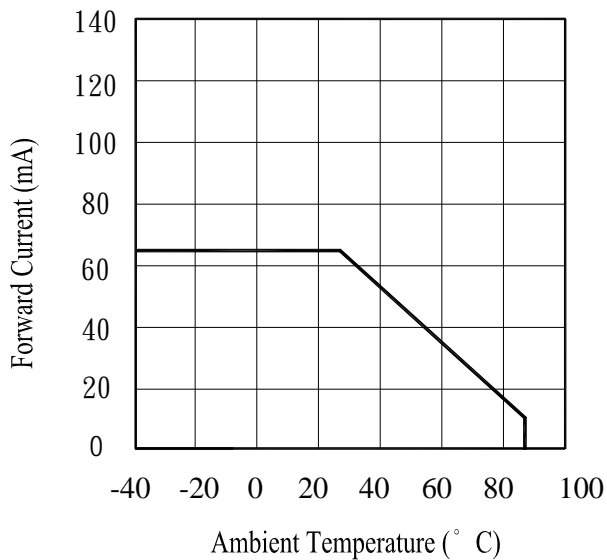


Fig.2 Spectral Distribution

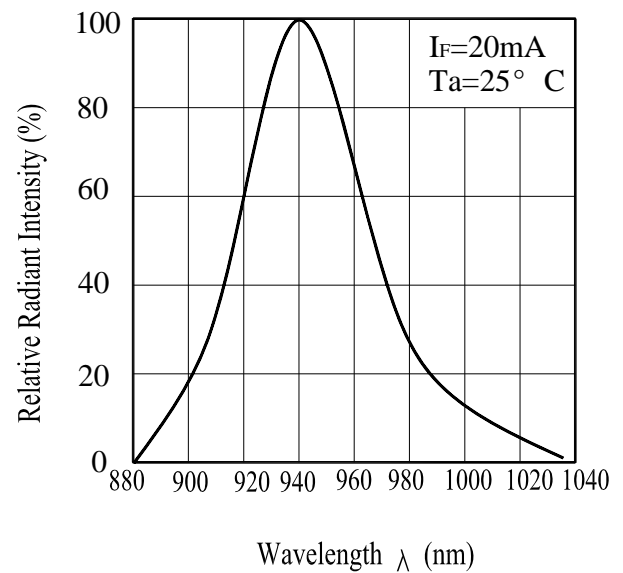


Fig.3 Peak Emission Wavelength vs. Ambient Temperature

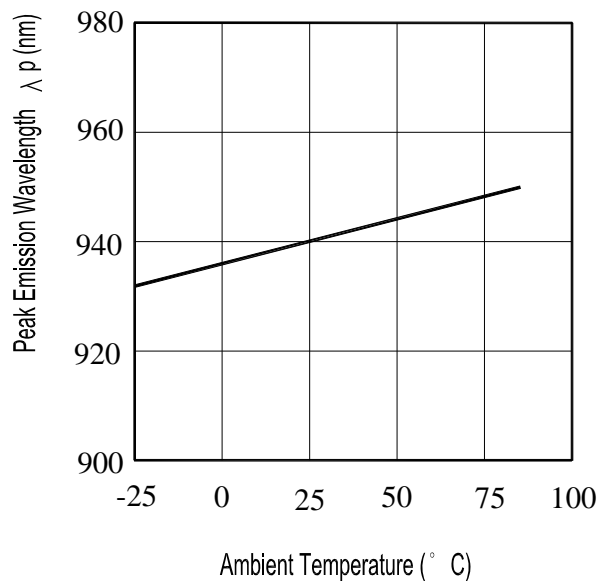
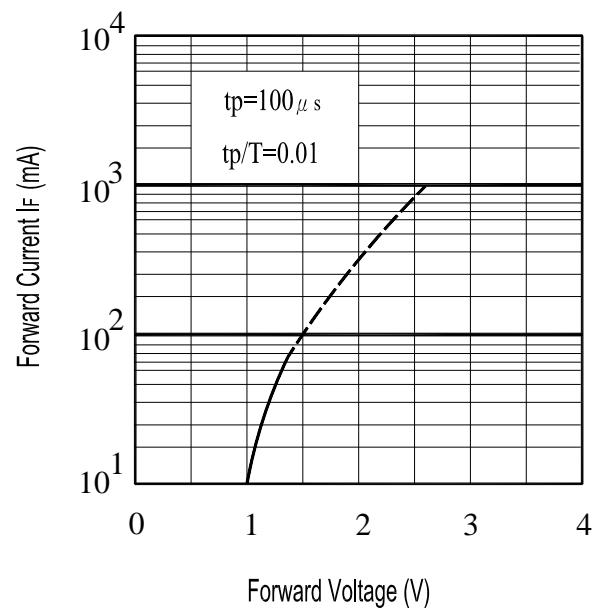


Fig.4 Forward Current vs. Forward Voltage



Typical Electro-Optical Characteristics Curves

Fig.5 Relative Intensity vs.

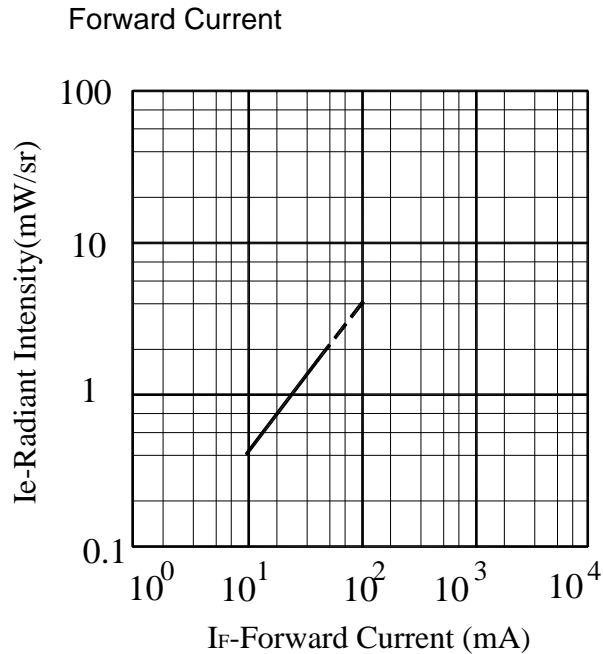


Fig.6 Relative Radiant Intensity vs.

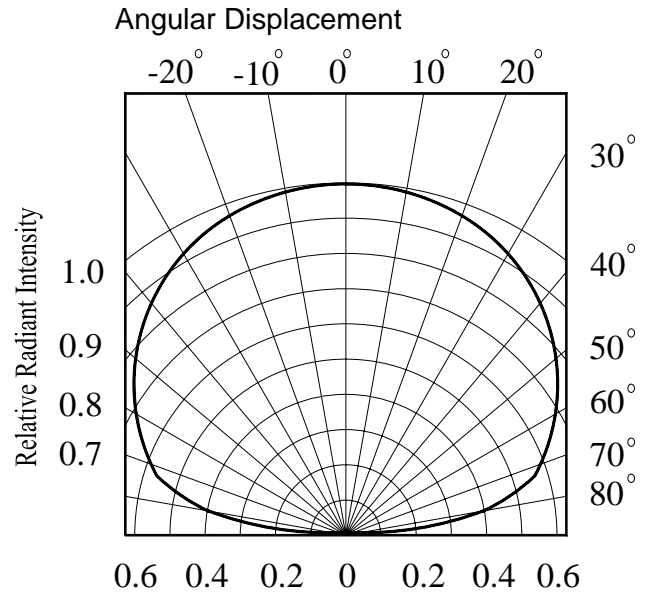


Fig.7 Relative Intensity vs.

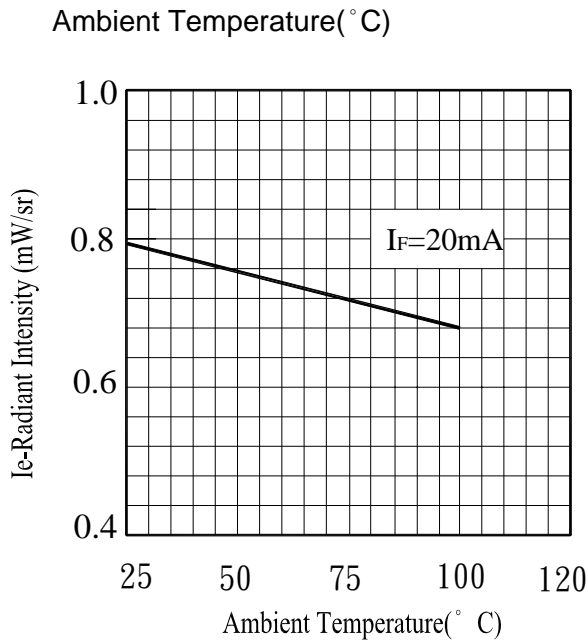
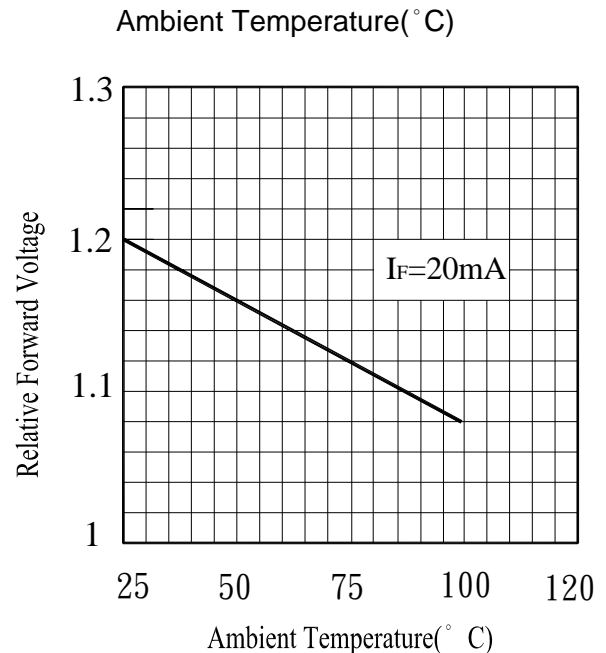


Fig.8 Forward Voltage vs.



Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection , otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

2.1 Do not open moisture proof bag before the products are ready to use.

2.2 Before opening the package, the LEDs should be kept at 30°C or less and 90%RH or less.

2.3 The LEDs should be used within a year.

2.4 After opening the package, the LEDs should be kept at 30°C or less and 70%RH or less.

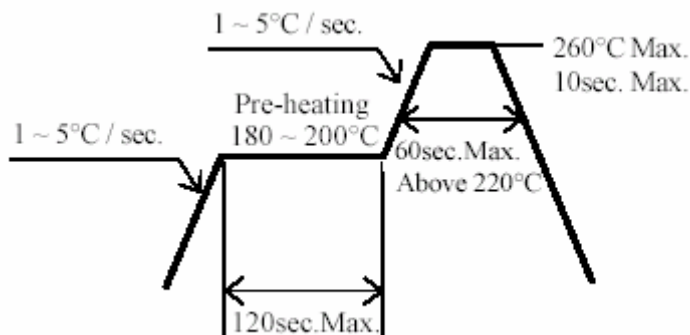
2.5 The LEDs should be used within 168 hours (7 days) after opening the package.

2.6 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment : $60\pm5^{\circ}\text{C}$ for 24 hours.

3. Soldering Condition

3.1 Pb-free solder temperature profile



3.2 Reflow soldering should not be done more than two times.

3.3 When soldering, do not put stress on the LEDs during heating.

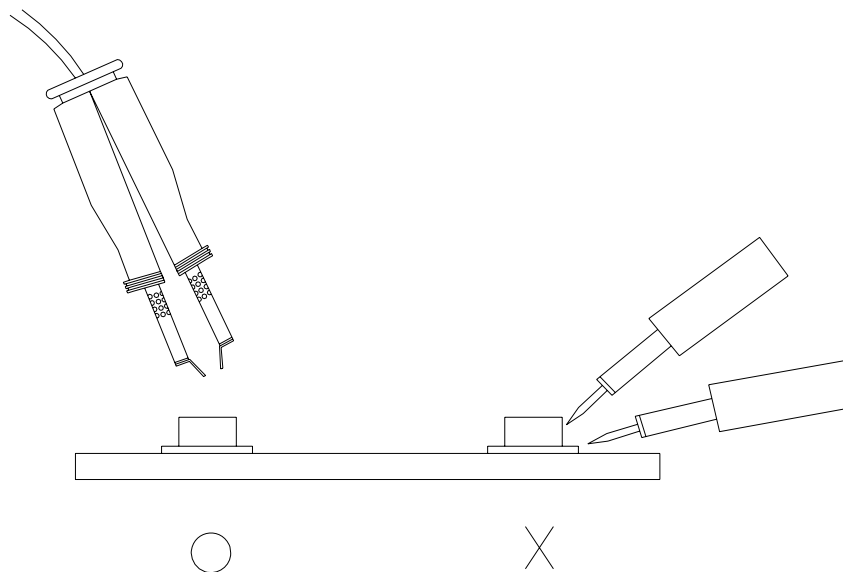
3.4 After soldering, do not warp the circuit board.

4.Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 280°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



Reliability Test Item And Condition

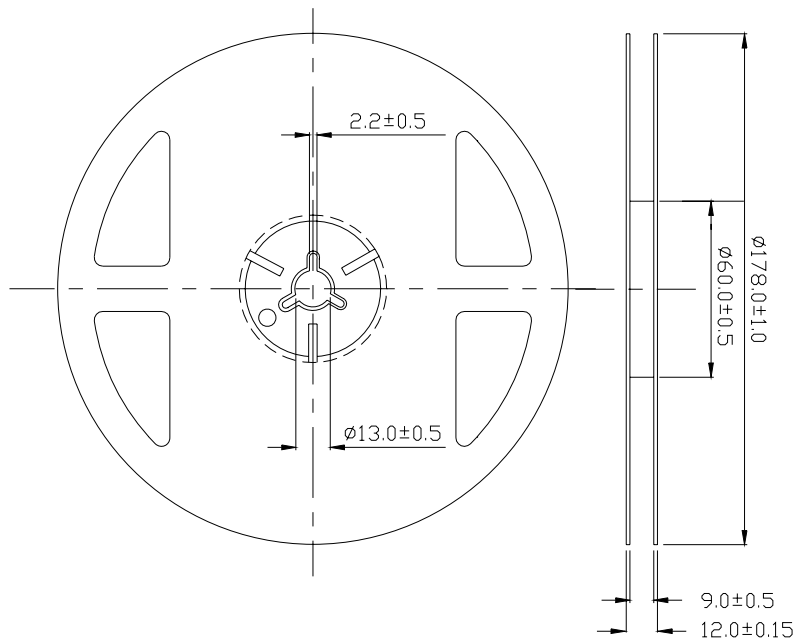
The reliability of products shall be satisfied with items listed below.

Confidence level : 90%

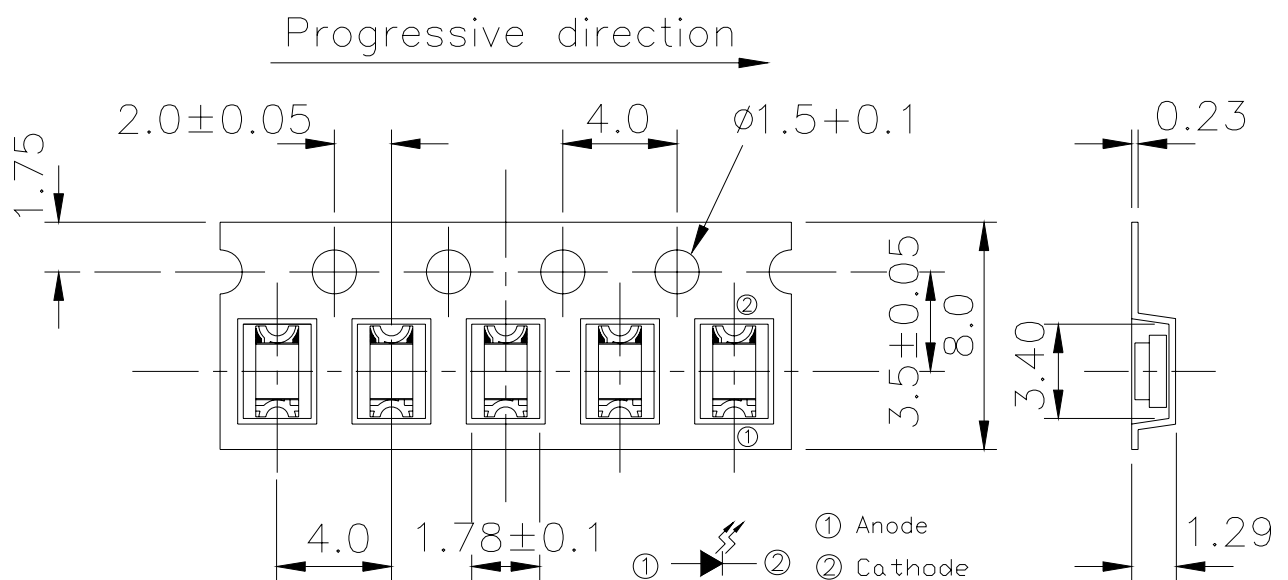
LTPD : 10%

| NO. | Item | Test Conditions | Test Hours/ Cycles | Sample Sizes | Failure Judgement Criteria | Ac/Re |
|-----|------------------------------------|--|-----------------------|-----------------|--|-------|
| 1 | REFLOW Soldering | TEMP. : $260^{\circ}\text{C} \pm 5^{\circ}\text{C}$ 10secs | 6Mins | 22pcs | $I_R \geq U \times 2$ | 0/1 |
| 2 | Temperature Cycle | H : $+100^{\circ}\text{C}$ 15mins ↓ 5mins L : -40°C 15mins | 50Cycles | 22pcs | $I_E \leq L \times 0.8$ $V_F \geq U \times 1.2$ | 0/1 |
| 3 | Thermal Shock | H : $+100^{\circ}\text{C}$ 5mins ↓ 10secs L : -10°C 5mins | 50Cycles | 22pcs | U : Upper Specification Limit | 0/1 |
| 4 | High Temperature Storage | TEMP. : $+100^{\circ}\text{C}$ | 1000hrs | 22pcs | L : Lower Specification Limit | 0/1 |
| 5 | Low Temperature Storage | TEMP. : -40°C | 1000hrs | 22pcs | | 0/1 |
| 6 | DC Operating Life | $I_F = 20\text{mA}$ | 1000hrs | 22pcs | | 0/1 |
| 7 | High Temperature/ High Humidity | 85°C / 85% R.H | 1000hrs | 22pcs | | 0/1 |

Package Dimensions



Taping Dimensions



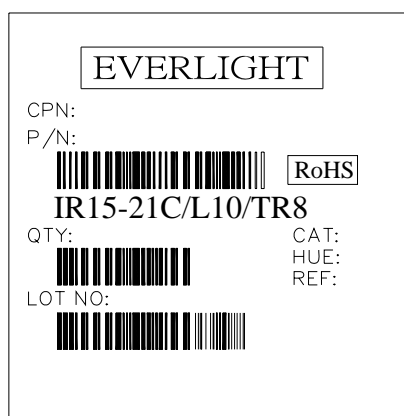
Unit:mm

Packing Quantity Specification

1.2000Pcs/1Volume , 1Volume/1Bag

2.10Boxes/1Carton

Label Form Specification



CPN: Customer's Production Number

P/N : Production Number

QTY: Packing Quantity

CAT: Ranks

HUE: Peak Wavelength

REF: Reference

LOT No: Lot Number

MADE IN TAIWAN: Production Place

Notes

1. Above specification may be changed without notice. EVERLIGHT will reserve authority on material change for above specification.
2. When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
3. These specification sheets include materials protected under copyright of EVERLIGHT corporation. Please don't reproduce or cause anyone to reproduce them without EVERLIGHT's consent.

EVERLIGHT ELECTRONICS CO., LTD.

Office: No 25, Lane 76, Sec 3, Chung Yang Rd,
Tucheng, Taipei 236, Taiwan, R.O.C

Tel: 886-2-2267-2000, 2267-9936

Fax: 886-2267-6244, 2267-6189, 2267-6306

<http://www.everlight.com>